

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Atty. Docket: NAKADA3

In re Application of:) Conf. No.: 7874
Tsutomu NAKADA)
) Washington, D.C.
Filed: April 2, 2004)
)
U.S. Appln. No.: 10/816,168)
) October 13, 2004
)
For: COPPER PLATING BATH AND)
PLATING METHOD)

PRELIMINARY AMENDMENT

Mail Stop Missing Parts
Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

Sir:

Prior to examination on the merits, and prior to
calculation of the filing fee, kindly amend as follows:

Amendments to the Specifications begin on page 2 of this
paper.

Remarks begin on page 4.